PIC18F87J72 Evaluation Board User’s Guide
Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Trademarks

The Microchip name and logo, the Microchip logo, dsPIC, KEELoQ, KEELoQ logo, MPLAB, PIC, PICmicro, PICSTART, PIC32 logo, rPIC and U/I/O are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

FilterLab, Hampshire, HI-TECH C, Linear Active Thermistor, MXDEV, MXLAB, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Analog-for-the-Digital Age, Application Maestro, chipKIT, chipKIT logo, CodeGuard, dsPICDEM, dsPICDEM.net, dsPICworks, dsSPEAK, ECAN, ECONOMONITOR, FanSense, Hi-TIDE, In-Circuit Serial Programming, ICSP, Mindi, MIWi, MPASM, MPLAB Certified logo, MPLIB, MPLINK, mTouch, Omniscient Code Generation, PICC, PICC-18, PICDEM, PICDEM.net, PICkit, PICtail, REAL ICE, rfLAB, Select Mode, Total Endurance, TSHARC, UniWinDriver, WiperLock and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

All other trademarks mentioned herein are property of their respective companies.

© 2011, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

Printed on recycled paper.


Microchip received ISO/TS-16949:2002 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company’s quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELoQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip’s quality system for the design and manufacture of development systems is ISO 9001:2000 certified.
# Table of Contents

Preface ............................................................................................................................................. 5  
  Introduction ...................................................................................................................................... 5  
  Document Layout ............................................................................................................................ 6  
  Recommended Reading .................................................................................................................... 7  
  The Microchip Web Site ................................................................................................................... 7  
  Customer Support ............................................................................................................................ 8  
  Document Revision History ............................................................................................................. 8  

Chapter 1. Product Overview  
  1.1 Introduction ............................................................................................................................... 9  
  1.2 PIC18F87J72 Evaluation Board Functionality and Features ......................................................... 9  
  1.3 PIC18F87J72 EVALUATION BOARD KIT CONTENTS ................................................................. 10  

Chapter 2. Hardware Description  
  2.1 Introduction ................................................................................................................................ 11  

Chapter 3. PIC18F87J72 Evaluation Board Features  
  3.1 Introduction ................................................................................................................................ 17  

Chapter 4. PIC18F87J72 Evaluation Board Firmware Flowchart  
  4.1 Introduction ................................................................................................................................ 23  

Chapter 5. PIC18F87J72 Evaluation Board Lab Test Results  
  5.1 Introduction ................................................................................................................................ 31  

Chapter 6. PIC18F87J72 Evaluation Board GUI  
  6.1 Introduction ................................................................................................................................ 35
Appendix A. Schematics and Layouts

A.1 Introduction ................................................................. 37
A.2 Board – Schematic 1 ...................................................... 38
A.3 Board – Schematic 2 ...................................................... 39
A.4 Board – Schematic 3 ...................................................... 40
A.5 Board – Schematic 4 ...................................................... 41
A.6 Board – PCB Front Page ............................................... 42
A.7 Board – PCB Top Silk ................................................... 43
A.8 Board – PCB Top Layer ................................................ 44
A.9 Board – PCB Bottom Layer ......................................... 45
A.10 Board – PCB Bottom Silk .......................................... 46
A.11 Board – PCB L1 Ground .............................................. 47
A.12 Board – PCB L2 VDD .................................................. 48

Appendix B. Bill of Materials (BOM)

Worldwide Sales and Service .............................................. 52
NOTICE TO CUSTOMERS

All documentation becomes dated, and this manual is no exception. Microchip tools and documentation are constantly evolving to meet customer needs, so some actual dialogs and/or tool descriptions may differ from those in this document. Please refer to our web site (www.microchip.com) to obtain the latest documentation available.

Documents are identified with a “DS” number. This number is located on the bottom of each page, in front of the page number. The numbering convention for the DS number is “DSXXXXXXA”, where “XXXXXX” is the document number and “A” is the revision level of the document.

For the most up-to-date information on development tools, see the MPLAB® IDE on-line help. Select the Help menu, and then Topics to open a list of available on-line help files.

INTRODUCTION

This chapter contains the general information that will be useful to know before using the PIC18F87J72 Evaluation Board. Items discussed in this chapter include:

• Document Layout
• Recommended Reading
• The Microchip Web Site
• Customer Support
• Document Revision History
This document describes how to use the PIC18F87J72 Evaluation Board as a development tool to emulate and debug firmware on a target board. The manual layout is as follows:

• Chapter 1. “Product Overview” – Provides a brief overview of the PIC18F87J72 Evaluation Board, its features and uses.
• Chapter 2. “Hardware Description” – Provides a detailed description of the PIC18F87J72 Evaluation Board hardware features.
• Chapter 3. “PIC18F87J72 Evaluation Board Features” – Provides details on how to use and configure the PIC18F87J72 Evaluation Board.
• Chapter 4. “PIC18F87J72 Evaluation Board Firmware Flowchart” – Provides the flow charts for various functions and routines in the firmware.
• Chapter 5. “PIC18F87J72 Evaluation Board Lab Test Results” – Provides the various lab test results obtained when working on a debugging environment using MPLAB® IDE.
• Chapter 6. “PIC18F87J72 Evaluation Board GUI” – Provides details on the Graphical User Interface (GUI) used for plotting the various signals in time and frequency domain for spectral analysis.
• Appendix A. “Schematics and Layouts” – Provides schematic and board layouts of the PIC18F87J72 Evaluation Board.
• Appendix B. “Bill of Materials (BOM)” – Provides details of all the components with part numbers and designators used for the PIC18F87J72 Evaluation Board.
RECOMMENDED READING

This user’s guide describes how to use PIC18F87J72 Evaluation Board. Other useful documents are listed below. The following Microchip documents are available and recommended as supplemental reference resources.

MPLAB® IDE Simulator, Editor User's Guide (DS51025)

Refer to this document for more information on installation and implementation of the MPLAB Integrated Development Environment (IDE) software.

THE MICROCHIP WEB SITE

Microchip provides online support through our web site at www.microchip.com. This web site is used as a means to make files and information easily available to customers. Accessible by using your favorite Internet browser, the web site contains the following information:

• **Product Support** – Data sheets and errata, application notes and sample programs, design resources, user’s guides and hardware support documents, latest software releases and archived software

• **General Technical Support** – Frequently Asked Questions (FAQs), technical support requests, online discussion groups, Microchip consultant program member listing

• **Business of Microchip** – Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives
CUSTOMER SUPPORT

Users of Microchip products can receive assistance through several channels:

• Distributor or Representative
• Local Sales Office
• Field Application Engineer (FAE)
• Technical Support
• Development Systems Information Line

Customers should contact their distributor, representative or field application engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

Technical support is available through the web site at: http://support.microchip.com

DOCUMENT REVISION HISTORY

Revision A (June 2011)

This is the initial release of this document.
Chapter 1. Product Overview

1.1 INTRODUCTION

This chapter provides an overview of the PIC18F87J72 Evaluation Board. This board is used as a development tool and as evaluation kit for PIC18F87J72 based applications. 

Topics discussed in this chapter include:
- Development Kit Contents
- Evaluation Board Functionality and Features

1.2 PIC18F87J72 EVALUATION BOARD FUNCTIONALITY AND FEATURES

The PIC18F87J72 Evaluation Board provides a platform for developing and evaluating applications which are based on the PIC18F87J72 device. These applications can range from accurate measurement of low signals like an output signal of a load cell to processing of information for metering and other metrology applications like energy metering, heatmeter and so on.

The PIC18F87J72 microcontroller has an 8-bit core processor along with many advanced peripherals like 12-bit SAR-based ADC, two 24-bit delta sigma ADCs and Charge Time Measurement unit (CTMU) for temperature measurement or implementation of touch keys.

PIC18F87J72 also has built-in Real Time Clock and Calendar (RTCC) with calibration registers for time stamping the measured data, and a Liquid Crystal Display (LCD) driver for a display up to 132 pixels.

The PIC18F87J72 Evaluation Board has the following features to develop and test user applications:
- Easy connection for low and high voltage signals. Signals from variety of sensors can be connected to this board.
- Touch keys to select different parameters of the of the 24-bit Delta Sigma ADC, like Over Sampling Ratio (OSR), Resolution, and Channel gain.
- Direct LCD display, driven from the COM/SEG pins of PIC18F87J72
- Real Time Clock
- Temperature Measurement option with CTMU

The PIC18F87J72 Evaluation Board can be connected to the GUI, supplied along with the board, to analyze the synchronous sampling, 24-bit, delta sigma ADCs. The ADCs have 90 dB SINAD and -104dB THD (up to the 35th harmonic) for each channel, enabling highly accurate energy metering and other low signal level designs. With less than 10 mVRMS output noise and a programmable gain amplifier of up to 32 V/V, these 24-bit ADCs are capable of interfacing to a large variety of small signal sensors, as well as voltage and current sensors, including shunts, Current Transformers (CT), Rogowski coils, Hall Effect sensors and load cells.
1.3 PIC18F87J72 EVALUATION BOARD KIT CONTENTS

This PIC18F87J72 Evaluation Board kit includes:

- PIC18F87J72 Evaluation Board
- Pre-Programmed PIC18F87J72 microcontroller on board
- MCP2200 device on board
- GUI
- LAB VIEW installation software for the GUI
  - Visa 441 runtime
  - LVRTE86std
- Mini Universal Serial Bus (USB) connecting cable
Chapter 2. Hardware Description

2.1 INTRODUCTION

This chapter describes the various sections of the hardware present on the evaluation board. It also describes the different configurations possible for operating the evaluation board, depending upon the input voltage and current specifications. Figure 2-1 shows the overall layout of the PIC18F87J72 Evaluation Board where the different hardware sections are indicated by numbers. Table 2-1 lists the descriptions for each hardware component.

**FIGURE 2-1:** Layout of the PIC18F87J72 Evaluation Board.

Legend:

1. PIC18F87J72 microcontroller
2. Seven segment LCD
3. High voltage section with connectors
4. RJ11 connector
5. Load Cell connector
6. PICtail™ connector
7. Touch sensitive keys
8. 9V battery connector
9. MCP2200 – USB to Universal Asynchronous receiver/transmitter (UART) serial converter
10. Mini B USB receptacle
11. 9V power supply jack
12. 32.768 kHz crystal
13. 10 MHz crystal
2.1.1 PIC18F87J72 Evaluation Board Jumper Settings

Table 2-2 shows the various jumpers available on the PIC18F87J72 Evaluation Board. By connecting the jumper pins appropriately, different configurations can be achieved on the board. Care must be taken regarding the voltage level before placing these jumpers. Further sections in this document describe what precautions need to be ensured while connecting these jumpers.

**TABLE 2-2: JUMPERS ON THE EVALUATION BOARD**

<table>
<thead>
<tr>
<th>SI NO</th>
<th>Device</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>JP1</td>
<td>Selection between high voltage and low voltage input on channel CH0</td>
</tr>
<tr>
<td>2</td>
<td>JP2</td>
<td>To ground Pin 1 of J4</td>
</tr>
<tr>
<td>3</td>
<td>JP3</td>
<td>Used for burden connections when CT output is connected to J4</td>
</tr>
<tr>
<td>4</td>
<td>JP4</td>
<td>To ground Pin 3 of J4</td>
</tr>
<tr>
<td>5</td>
<td>JP5</td>
<td>To ground Pin 1 of J5</td>
</tr>
<tr>
<td>6</td>
<td>JP6</td>
<td>Used for burden connections when CT output is connected to J5</td>
</tr>
<tr>
<td>7</td>
<td>JP7</td>
<td>To ground Pin 3 of J5</td>
</tr>
<tr>
<td>8</td>
<td>JP8</td>
<td>Selection between high voltage and low voltage input on channel CH1</td>
</tr>
</tbody>
</table>
2.1.2 Measurement of High Voltages

The circuit diagrams in the schematics section of Appendix A. “Schematics and Layouts”, provide details on the resistor values used for dividing the network of the input voltage. Table 2-3 provides a quick reference to resistor values in the high voltage section.

### TABLE 2-3: RESISTORS FOR HIGH VOLTAGE MEASUREMENT

<table>
<thead>
<tr>
<th>Register</th>
<th>Value (KΩ)</th>
</tr>
</thead>
<tbody>
<tr>
<td>R23 and R30</td>
<td>330</td>
</tr>
<tr>
<td>R24 and R31</td>
<td>330</td>
</tr>
<tr>
<td>R25 and R32</td>
<td>120</td>
</tr>
<tr>
<td>R33 and R35</td>
<td>1</td>
</tr>
<tr>
<td>R37 and R39</td>
<td>1</td>
</tr>
</tbody>
</table>

When measuring a high voltage signal on the input terminals of channels CH0 and CH1, refer to Table 2-4 and Table 2-5. These tables provide the configuration of jumpers, along with the amplitude of the voltage available at the various points. The high voltage can be in the universal range of input voltage ranging from 85-265 Volts\(_\text{rms}\) (V\(_\text{rms}\)) at 50 Hz or 60 Hz.

### TABLE 2-4: JUMPER SETTINGS FOR HIGH VOLTAGE MEASUREMENT ON CH0

<table>
<thead>
<tr>
<th>Voltage (V(_\text{rms}))</th>
<th>JP1</th>
<th>JP2</th>
<th>JP3</th>
<th>JP4</th>
<th>ADC I/P (V(_\text{rms}))</th>
<th>ADC I/P (Vpeak)</th>
<th>Remark</th>
</tr>
</thead>
<tbody>
<tr>
<td>80</td>
<td>Short 1-2</td>
<td>Open</td>
<td>Open</td>
<td>Short</td>
<td>0.10230</td>
<td>0.14468</td>
<td>Internal Gain of 2 can be used for better resolution</td>
</tr>
<tr>
<td>110</td>
<td>Short 1-2</td>
<td>Open</td>
<td>Open</td>
<td>Short</td>
<td>0.14066</td>
<td>0.19893</td>
<td></td>
</tr>
<tr>
<td>220</td>
<td>Short 1-2</td>
<td>Open</td>
<td>Open</td>
<td>Short</td>
<td>0.28133</td>
<td>0.39786</td>
<td></td>
</tr>
<tr>
<td>270</td>
<td>Short 1-2</td>
<td>Open</td>
<td>Open</td>
<td>Short</td>
<td>0.34527</td>
<td>0.48828</td>
<td></td>
</tr>
<tr>
<td>280</td>
<td>Short 1-2</td>
<td>Open</td>
<td>Open</td>
<td>Short</td>
<td>0.35806</td>
<td>0.50637</td>
<td>Max Differential ADC I/P is 0.5V</td>
</tr>
</tbody>
</table>

### TABLE 2-5: JUMPER SETTINGS FOR HIGH VOLTAGE MEASUREMENT ON CH1

<table>
<thead>
<tr>
<th>Voltage (V(_\text{rms}))</th>
<th>JP8</th>
<th>JP5</th>
<th>JP6</th>
<th>JP7</th>
<th>ADC I/P (V(_\text{rms}))</th>
<th>ADC I/P (Vpeak)</th>
<th>Remark</th>
</tr>
</thead>
<tbody>
<tr>
<td>80</td>
<td>Short 1-2</td>
<td>Open</td>
<td>Open</td>
<td>Short</td>
<td>0.10230</td>
<td>0.14468</td>
<td>Internal Gain of 2 can be used for better resolution</td>
</tr>
<tr>
<td>110</td>
<td>Short 1-2</td>
<td>Open</td>
<td>Open</td>
<td>Short</td>
<td>0.14066</td>
<td>0.19893</td>
<td></td>
</tr>
<tr>
<td>220</td>
<td>Short 1-2</td>
<td>Open</td>
<td>Open</td>
<td>Short</td>
<td>0.28133</td>
<td>0.39786</td>
<td></td>
</tr>
<tr>
<td>270</td>
<td>Short 1-2</td>
<td>Open</td>
<td>Open</td>
<td>Short</td>
<td>0.34527</td>
<td>0.48828</td>
<td></td>
</tr>
<tr>
<td>280</td>
<td>Short 1-2</td>
<td>Open</td>
<td>Open</td>
<td>Short</td>
<td>0.35806</td>
<td>0.50637</td>
<td>Max Differential ADC I/P is 0.5V</td>
</tr>
</tbody>
</table>

**Note 1:** The precautions given need to be strictly adhered to, in order to avoid any damage to the evaluation board and prevent electric shock hazard.

2: Input high voltage AC signal can be applied between pins 1 and 2 of the connector J4 or J5.

3: The resistors R26 and R27 should not be populated when pins 1 and 2 of J4 are connected to a high voltage.

4: The resistors R28 and R29 should not be populated when pins 1 and 2 of J5 are connected to a high voltage.

5: The resistors R26, R27, R28 and R29 can be used only when CT outputs are connected to the connectors J4 and J5. In this case, these resistors act as a burden resistor to the CT secondary winding.
2.1.3 Measurement of Low Voltages

The circuit diagrams in the schematics section of Appendix A. “Schematics and Lay-outs”, provide details on the resistor values used for the low voltage circuit. Table 2-6 provides a quick reference to resistor values in the low voltage section.

<table>
<thead>
<tr>
<th>TABLE 2-6: RESISTORS FOR LOW VOLTAGE MEASUREMENT</th>
</tr>
</thead>
<tbody>
<tr>
<td>Register</td>
</tr>
<tr>
<td>--------------</td>
</tr>
<tr>
<td>R34 and R36</td>
</tr>
<tr>
<td>R33 and R35</td>
</tr>
<tr>
<td>R37 and R39</td>
</tr>
<tr>
<td>R38 and R40</td>
</tr>
</tbody>
</table>

When measuring a low voltage signal on the input terminals of channels CH0 and CH1, refer to Table 2-7 and Table 2-8. These tables provide the configuration of jumpers, along with the amplitude of the voltage available at the various points. The low voltage signal can be either an AC signal, a DC signal or a signal of any arbitrary wave shape.

<table>
<thead>
<tr>
<th>TABLE 2-7: JUMPER SETTINGS FOR LOW VOLTAGE MEASUREMENT ON CH0</th>
</tr>
</thead>
<tbody>
<tr>
<td>CH0 Jumper Position</td>
</tr>
<tr>
<td>---------------------</td>
</tr>
<tr>
<td>Voltage (Vrms)</td>
</tr>
<tr>
<td>0.1 Short 2-3 Open Open Short</td>
</tr>
<tr>
<td>0.2 Short 2-3 Open Open Short</td>
</tr>
<tr>
<td>0.5 Short 2-3 Open Open Short</td>
</tr>
<tr>
<td>1 Short 2-3 Open Open Short</td>
</tr>
<tr>
<td>1.1 Short 2-3 Open Open Short</td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>TABLE 2-8: JUMPER SETTINGS FOR LOW VOLTAGE MEASUREMENT ON CH1</th>
</tr>
</thead>
<tbody>
<tr>
<td>CH1 Jumper Position</td>
</tr>
<tr>
<td>---------------------</td>
</tr>
<tr>
<td>Voltage (Vrms)</td>
</tr>
<tr>
<td>0.1 Short 2-3 Open Open Short</td>
</tr>
<tr>
<td>0.2 Short 2-3 Open Open Short</td>
</tr>
<tr>
<td>0.5 Short 2-3 Open Open Short</td>
</tr>
<tr>
<td>1 Short 2-3 Open Open Short</td>
</tr>
<tr>
<td>1.1 Short 2-3 Open Open Short</td>
</tr>
</tbody>
</table>

Note 1: Input low voltage signal can be applied between pins 1 and 2 of the connector J4 or J5.
2.1.4 Measurement of Current Signals

The circuit diagrams in the schematics section of Appendix A, “Schematics and Layouts”, provide details on the resistor values used for the current measurement circuit. Table 2-9 provides a quick reference to resistor values while measuring the current signals. The output of Current Transformers (CTs) can be connected to the input connector pins.

TABLE 2-9: RESISTORS FOR LOW VOLTAGE MEASUREMENT

<table>
<thead>
<tr>
<th>Register</th>
<th>Value (KΩ)</th>
</tr>
</thead>
<tbody>
<tr>
<td>R26 and R28</td>
<td>0.063</td>
</tr>
<tr>
<td>R27 and R29</td>
<td>0.063</td>
</tr>
<tr>
<td>R34 and R36</td>
<td>1</td>
</tr>
<tr>
<td>R33 and R35</td>
<td>1</td>
</tr>
<tr>
<td>R37 and R39</td>
<td>1</td>
</tr>
<tr>
<td>R38 and R40</td>
<td>1</td>
</tr>
</tbody>
</table>

When measuring a current signal on the input terminals of channels CH0 and CH1, refer to Table 2-10 and Table 2-11. These tables provide the configuration of jumpers, along with the amplitude of the voltage available at the various points.

TABLE 2-10: JUMPER SETTINGS FOR CURRENT MEASUREMENT ON CH0

<table>
<thead>
<tr>
<th>CH0 Jumper Position</th>
<th>CT Primary Current (Irms-A)</th>
<th>JP1</th>
<th>JP2</th>
<th>JP3</th>
<th>JP4</th>
<th>ADC I/P (Vrms)</th>
<th>ADC I/P (Vpeak)</th>
<th>Remark</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>0.1</td>
<td>Short</td>
<td>2-3</td>
<td>Open</td>
<td>Short</td>
<td>Open</td>
<td>0.00063</td>
<td>0.00089</td>
</tr>
<tr>
<td></td>
<td>0.5</td>
<td>Short</td>
<td>2-3</td>
<td>Open</td>
<td>Short</td>
<td>Open</td>
<td>0.00315</td>
<td>0.00445</td>
</tr>
<tr>
<td></td>
<td>1</td>
<td>Short</td>
<td>2-3</td>
<td>Open</td>
<td>Short</td>
<td>Open</td>
<td>0.0063</td>
<td>0.00891</td>
</tr>
<tr>
<td></td>
<td>10</td>
<td>Short</td>
<td>2-3</td>
<td>Open</td>
<td>Short</td>
<td>Open</td>
<td>0.063</td>
<td>0.08910</td>
</tr>
<tr>
<td></td>
<td>20</td>
<td>Short</td>
<td>2-3</td>
<td>Open</td>
<td>Short</td>
<td>Open</td>
<td>0.126</td>
<td>0.17819</td>
</tr>
<tr>
<td></td>
<td>30</td>
<td>Short</td>
<td>2-3</td>
<td>Open</td>
<td>Short</td>
<td>Open</td>
<td>0.189</td>
<td>0.26729</td>
</tr>
</tbody>
</table>
TABLE 2-11: JUMPER SETTINGS FOR CURRENT MEASUREMENT ON CH1

<table>
<thead>
<tr>
<th>CT Primary Current (Irms-A)</th>
<th>CH1 Jumper Position</th>
<th>ADC</th>
<th>ADC I/P (Vrms)</th>
<th>ADC I/P (Vpeak)</th>
<th>Remark</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>JP1</td>
<td>JP2</td>
<td>JP3</td>
<td>JP4</td>
<td></td>
</tr>
<tr>
<td>0.1</td>
<td>Short 2-3</td>
<td>Open</td>
<td>Short</td>
<td>Open</td>
<td>0.00063</td>
</tr>
<tr>
<td>0.5</td>
<td>Short 2-3</td>
<td>Open</td>
<td>Short</td>
<td>Open</td>
<td>0.00315</td>
</tr>
<tr>
<td>1</td>
<td>Short 2-3</td>
<td>Open</td>
<td>Short</td>
<td>Open</td>
<td>0.0063</td>
</tr>
<tr>
<td>10</td>
<td>Short 2-3</td>
<td>Open</td>
<td>Short</td>
<td>Open</td>
<td>0.063</td>
</tr>
<tr>
<td>20</td>
<td>Short 2-3</td>
<td>Open</td>
<td>Short</td>
<td>Open</td>
<td>0.126</td>
</tr>
<tr>
<td>30</td>
<td>Short 2-3</td>
<td>Open</td>
<td>Short</td>
<td>Open</td>
<td>0.189</td>
</tr>
</tbody>
</table>

Note 1: The precautions given need to be strictly adhered to, in order to avoid any damage to the evaluation board and prevent electric shock hazard.

2: I/P CT Secondary is connected between pins 1 and 3 of J4 and J5.

3: The resistors R26, R27, R28 and R29 need to be populated. These resistors act as burden resistors for CT secondary.

4: The calculations given in Table 2-10 and Table 2-11 are true for a CT ratio of 1:2500 and a burden resistance of 31.5(Ω).
Chapter 3. PIC18F87J72 Evaluation Board Features

3.1 INTRODUCTION

This chapter provides a brief description on how to use the PIC18F87J72 Evaluation Board for the measurement and analysis of various signals. It also describes the process of the demo and explains various configuration changes for observing the response using the PIC18F87J72 Evaluation Board.

Figure 3-1 shows the PIC18F87J72 Evaluation Board with the 9V supply connected to the input jack. The initial set up of the evaluation board involves connecting the supply to the input jack of the board. This provides the required supply to the evaluation board. Alternatively, the 9V battery can be connected to power the board. In addition, the USB cable from the computer is connected to the mini USB connector on the board. This is used for transmitting and receiving data to and from the board, to and from the GUI tool. The input signal can be connected to connectors J4 and J5. If the microcontroller is already programmed, then the program will start executing when the supply is turned on.

FIGURE 3-1: PIC18F87J72 Evaluation Board and OSR Configuration.
If the evaluation board is used in programmer mode, then the waveforms and the response can be observed on the GUI. If the evaluation board is used in debugging mode, using the MPLAB IDE, then the user can see the response on the Data Monitor and Control Interface (DMCI) window.

For debugging, the Real ICE/ICD debugger and programmer is connected to the RJ11 connector. After the software is compiled and programmed to the PIC18F87J72 device, the program can be executed. The LCD display on the board will indicate the time and the waveforms that can be observed on the GUI window or DMCI. The LCD display on the board will indicate the time. The various waveforms applied at the input can be observed on the GUI or DMCI.

Various changes to the device configuration can be done using the touch sensitive keys S1, S2, S3 and S4. The on-chip CTMU peripheral is used for all the touch-sensitive keys.

Press the key S1, to change the Over Sampling Ratio (OSR) as shown in Figure 3-1. There are four OSR configurations that can be created using S1. Each press of the key S1 will change the configuration of the sigma delta ADC with OSR values from a value of 256, 128, 64 and 32.

The time from the RTCC can also be displayed using the key S1 as shown in Figure 3-2.

The RTCC date and time can be set using the following steps:

- Press the keys S2 and S4 simultaneously to enter into the RTCC date setting mode. The date field on the LCD will start blinking.
- The date can be changed by pressing the key S4 for incrementing and S2 for decrementing. The key S1 can be used to set the day, month and year fields.
- Press the keys S1 and S2 simultaneously, to enter into the RTCC time setting mode. The time field on the LCD will start blinking.
- The time can be changed by pressing the key S4 for incrementing and S2 for decrementing. The key S1 can be used to set the hour, minute and second fields.

By pressing the key S1 repeatedly, the OSR configurations will sequentially change from 256 to 32 and then back to 256.

**FIGURE 3-2:** Displaying Time and Date
As shown in Figure 3-3, the S2 key is used for changing the internal PGA gain of the first channel. The gains can be changed from 1 to 32 with each press of the key. When pressing the S2 key repeatedly, the gain configurations of the Sigma Delta ADC will sequentially change from 1, 2, 4, 8, 16, 32 and then back to 1.

**FIGURE 3-3:** Configuring Internal PGA Gain for voltage channel.
Figure 3-4 shows the function of the S3 key, which is used to change the internal gain of the second input channel. The gains can be changed from 1 to 32 with each press of the key. When pressing the S3 key repeatedly, the gain configurations of the Sigma Delta ADC will sequentially change from 1, 2, 4, 8, 16, 32 and then back to 1.

**FIGURE 3-4:** Configuring Internal PGA Gain for Current Channel.
Figure 3-5 shows the function of the S4 key, which is used to change the bit width of the ADC conversion. Two configurations of the ADC bits are possible, either 16-bit or 24-bit. When the S4 key is pressed repeatedly, the bits toggle between 16 and 24-bit width.

**FIGURE 3-5:** Configuring the Number of Bits.
4.1 INTRODUCTION

This chapter provides the flowcharts describing the functions and routines implemented in the PIC18F87J72 Evaluation Board firmware.

Figures 4-1 – 4-6 show the flow of the following routines:

• Main routine (see Figure 4-1)
• Touch Key press routines (see Figure 4-2)
• Time display routines (see Figure 4-2)
• OSR switching routines (see Figure 4-2)
• Channel CH0 Gain switching routines (see Figure 4-3)
• Channel CH1 Gain switching routines (see Figure 4-4)
• Bit width changing routines (see Figure 4-5)
• UART Transmit Interrupt routine (see Figure 4-6)
• UART Receive Interrupt routine (see Figure 4-6)
• INT0 Interrupt routine (see Figure 4-6)
FIGURE 4-1: Main Routine
**FIGURE 4-2:** Key Press Routine to Configure OSR and Display Time.
FIGURE 4-3: Key Press Routine to Configure Gain of Channel CH0.
**FIGURE 4-4:** Key Press Routine to Configure Gain of Channel CH1.

- **gain2_value = 0**
  - Disable Global Interrupts
  - CH1 Gain=1, Write
  - Display GAIN = 1 on LCD
  - Enable Global Interrupts
  - Idle

- **gain2_value = 1**
  - Disable Global Interrupts
  - CH1 Gain=2, Write
  - Display GAIN = 2 on LCD
  - Enable Global Interrupts
  - Idle

- **gain2_value = 2**
  - Disable Global Interrupts
  - CH1 Gain=4, Write
  - Display GAIN = 4 on LCD
  - Enable Global Interrupts
  - Idle

- **gain2_value = 3**
  - Disable Global Interrupts
  - CH1 Gain=8, Write
  - Display GAIN = 8 on LCD
  - Enable Global Interrupts
  - Idle

- **gain2_value = 4**
  - Disable Global Interrupts
  - CH1 Gain=16, Write
  - Display GAIN = 16 on LCD
  - Enable Global Interrupts
  - Idle

- **gain2_value = 5**
  - Disable Global Interrupts
  - CH1 Gain=32, Write
  - Display GAIN = 32 on LCD
  - Enable Global Interrupts
  - Idle
FIGURE 4-5: Key Press Routine to Configure Bit Width of Channel CH0 and CH1.
**FIGURE 4-6:** Interrupt Service Routine for UART and INT0 Interrupts.
Chapter 5. PIC18F87J72 Evaluation Board Lab Test Results

5.1 INTRODUCTION

This chapter provides the various laboratory test results obtained when using the PIC18F87J72 Evaluation Board. This chapter also describes the use of the Data Monitor and Control Interface (DMCI) window to plot the waveforms present on Channel CH0 and CH1 of the evaluation board. Displaying waveforms on the DMCI window can only be done when the user is working in Debugging mode. In Debugging mode, the MPLAB IDE needs to be uploaded and the debugger connected to the RJ11 connector of the PIC18F87J72 Evaluation Board.

Figure 5-1 shows two graphs (i.e., Graph 1 and Graph 2). Graph 1 shows the waveform created on Channel CH0 of the PIC18F87J72 Evaluation Board. Graph 2 shows the waveform created on Channel CH1 of the PIC18F87J72 Evaluation Board. CH0 and CH1 are both connected to the same signal of 300 mV. The internal PGA gain is chosen to be 8 for CH0 and 1 for Channel CH1.

![DMCI Waveforms for 300mV Waveform with CH0 Gain = 8, CH1 Gain = 1.](image)

**FIGURE 5-1:** DMCI Waveforms for 300mV Waveform with CH0 Gain = 8, CH1 Gain = 1.
Figure 5-2 shows Graph 1 for CH0 and Graph 2 for CH1. The OSR for both CH0 and CH1 are chosen to be 32 and the signal amplitude applied at the input is a very low voltage sine wave signal of about 20 mV peak. The user can clearly observe the distortion of the waveform with such a low OSR value.

**FIGURE 5-2:** DMCI Waveforms for 20mV Waveform with OSR = 32 on CH0 and CH1.
Figure 5-3 shows Graph 1 for CH0 and Graph 2 for CH1. The OSR for both CH0 and CH1 are chosen to be 256 and the same signal is applied at the input with a very low voltage sine wave signal of about 20 mV peak. Here, the sine wave shape is still retained and the signal distortion is less when compared to Figure 5-2.

**FIGURE 5-3:** DMCI Waveforms for 20mV Waveform with OSR = 256 on CH0 and CH1.
Figure 5-4 shows Graph 1 for CH0 and Graph 2 for CH1. CH0 and CH1 are both connected to the same signal of 300 mV. The internal PGA gain is chosen to be 1 for CH0 and 32 for Channel CH1. The waveform on Graph 1 is intact, while the waveform on Graph 2 is saturated at a value of 32768. This demonstrates the effect of saturation when larger gains are used. This would distort the wave to a flat top waveform, and the information related to the shape of the signal would be lost.

**FIGURE 5-4:** DMCI Waveforms for 300mV Waveform with CH0 Gain = 1, CH1 Gain = 32.
Chapter 6. PIC18F87J72 Evaluation Board GUI

6.1 INTRODUCTION

This chapter describes the Graphical User Interface used for the PIC18F87J72 Evaluation Board. Figure 6-1 indicates the various waveforms and the parameters that can be displayed on the GUI. The signals can be viewed in their real-time state in Time domain as well as in Frequency domain. UART is used for communication between the GUI and the microcontroller. The baud rate used for communication is 38400. To use the GUI, the following run-time engines must be installed:

- Visa441runtime
- LVRTE86std

FIGURE 6-1: PIC18F87J72 Evaluation Board Graphical User Interface.
Appendix A. Schematics and Layouts

A.1 INTRODUCTION

This appendix contains the following schematics and layouts of the PIC18F87J72 Evaluation Board:

- Board – Schematic 1
- Board – Schematic 2
- Board – Schematic 3
- Board – Schematic 4
- Board – PCB Front Page
- Board – PCB Top Silk
- Board – PCB Top Layer
- Board – PCB Bottom Layer
- Board – PCB Bottom Silk
- Board – PCB L1 Ground
- Board – PCB L2 VDD
A.3 BOARD – SCHEMATIC 2

RG1* is Unused Pin
A.6 BOARD – PCB FRONT PAGE

Rev | Description | Date
--- | ----------- | ---
00  | Initial Revision | 08/25/10

Title: PIC18F87J72 Eval Board

Size: 130x100

Date: 25/Aug/2010

Drawn by: Nordam

File Name: 08-00333-R0.dip

Sheet: 1
A.9 BOARD – PCB BOTTOM LAYER
A.11 BOARD – PCB L1 GROUND
A.12 BOARD – PCB L2 V_{DD}
Appendix B. Bill of Materials (BOM)

This chapter provides the Bill of Materials for all the components and devices used on the PIC18F87J72 Evaluation Board.

**TABLE B-1: BILL OF MATERIALS (BOM)**

<table>
<thead>
<tr>
<th>Qty</th>
<th>Reference</th>
<th>Description</th>
<th>Manufacturer</th>
<th>Part Number</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>BAT1</td>
<td>BATTERY IND ALKALINE 9 VOLT</td>
<td>Energizer</td>
<td>EN22</td>
</tr>
<tr>
<td>1</td>
<td>BAT1</td>
<td>CONN PC VERT 9V SNAP-ON</td>
<td>Keystone</td>
<td>96B</td>
</tr>
<tr>
<td>4</td>
<td>C1, C3, C5, C7</td>
<td>CAP 47UF 16V ELECT FP SMD</td>
<td>Panasonic® ECG</td>
<td>EEE-FPC470UAR</td>
</tr>
<tr>
<td>16</td>
<td>C2, C4, C6, C8, C14, C15, C16, C17, C18, C19, C20, C21, C27, C28, C32, C33</td>
<td>CAP CER .1UF 25V Y5V 0603</td>
<td>Murata Electronics®</td>
<td>GRM188F51E104ZAA01D</td>
</tr>
<tr>
<td>5</td>
<td>C9, C10, C11, C12, C26</td>
<td>CAP CER 47000PF 50V X7R 10% 0603</td>
<td>TDK Corporation</td>
<td>C1608X7R1H473K</td>
</tr>
<tr>
<td>2</td>
<td>C13, C31</td>
<td>CAP 10UF 16V ELECT FP SMD</td>
<td>Panasonic ECG</td>
<td>EEE-FP1C100A</td>
</tr>
<tr>
<td>4</td>
<td>C22, C23, C29, C30</td>
<td>CAP CER 18PF 50V C0G 5% 0603</td>
<td>TDK Corporation</td>
<td>C1608C0G1H180J</td>
</tr>
<tr>
<td>2</td>
<td>C24, C25</td>
<td>CAP CER 12PF 50V C0G 5% 0603</td>
<td>TDK Corporation</td>
<td>C1608C0G1H120J</td>
</tr>
<tr>
<td>5</td>
<td>C34, C35, C36, C37, C38</td>
<td>CAP CER 10000PF 50V 10% X7R 0805</td>
<td>Murata Electronics</td>
<td>GRM216R71H103KA01D</td>
</tr>
<tr>
<td>4</td>
<td>D1, D3, D16, D17</td>
<td>DIODE SCHOTTKY 20V 500MA SOD123</td>
<td>Micro Commercial Components</td>
<td>MBR0520-TP</td>
</tr>
<tr>
<td>2</td>
<td>D2, D4</td>
<td>LED GREEN CLEAR 0805 SMD</td>
<td>Lite-On Semi.</td>
<td>LTST-C170GKT</td>
</tr>
<tr>
<td>2</td>
<td>D5, D6</td>
<td>LED YELLOW CLEAR 0805 SMD</td>
<td>Lite-On Semi.</td>
<td>LTST-C170YKT</td>
</tr>
<tr>
<td>9</td>
<td>D7, D8, D9, D10, D11, D12, D13, D14, D15</td>
<td>DIODE SWITCH 215MA 70V SOT-23</td>
<td>Comchip Tech.</td>
<td>BAV99-G</td>
</tr>
<tr>
<td>1</td>
<td>D18</td>
<td>DIODE 75V 150MA SOD323F</td>
<td>Fairchild Semi.</td>
<td>1N4148WS</td>
</tr>
<tr>
<td>1</td>
<td>J1</td>
<td>CONN POWERKJACK MINI R/A T/H</td>
<td>Switchcraft</td>
<td>RAPC722X</td>
</tr>
<tr>
<td>1</td>
<td>J2</td>
<td>CONN 6-6 MOD JACK</td>
<td>Stewart Connector</td>
<td>SS-7066-NF</td>
</tr>
<tr>
<td>1</td>
<td>J3</td>
<td>CONN USB RCPT MINI B 5PS R/A SMD</td>
<td>JAE Electronics</td>
<td>DX2R005HN2E700</td>
</tr>
<tr>
<td>2</td>
<td>J4, J5</td>
<td>TERMINAL BLOCK 5MM 3POS PCB</td>
<td>On-Shore Tech.</td>
<td>ED3101/3-WD</td>
</tr>
<tr>
<td>1</td>
<td>J6</td>
<td>TERMINAL BLOCK 5MM 2POS PCB</td>
<td>On-Shore Tech.</td>
<td>ED3101/2-WD</td>
</tr>
<tr>
<td>1</td>
<td>J7</td>
<td>CONN RECEPT 28POS .100 VERT DUAL</td>
<td>TE Connectivity</td>
<td>1-234998-4</td>
</tr>
<tr>
<td>1</td>
<td>J8</td>
<td>CONN RECEPT 12POS .100 VERT DUAL</td>
<td>3M</td>
<td>960230-6202-AR</td>
</tr>
<tr>
<td>1</td>
<td>J9</td>
<td>CONN HEADER 6POS .100° STR TIN</td>
<td>Molex</td>
<td>90120-0126</td>
</tr>
</tbody>
</table>
### TABLE B-1: BILL OF MATERIALS (BOM) (CONTINUED)

<table>
<thead>
<tr>
<th>Qty</th>
<th>Reference</th>
<th>Description</th>
<th>Manufacturer</th>
<th>Part Number</th>
</tr>
</thead>
<tbody>
<tr>
<td>2</td>
<td>JP1, JP8</td>
<td>CONN HEADER 3POS .100’ STR TIN</td>
<td>Molex</td>
<td>90120-0123</td>
</tr>
<tr>
<td>2</td>
<td>L1, L2</td>
<td>FERRITE CHIP 120 OHM 2000MA 0603</td>
<td>Murata Electronics</td>
<td>BLM18PG121SN1D</td>
</tr>
<tr>
<td>1</td>
<td>LCD1</td>
<td>Energy Meter LCD Display</td>
<td>Deepkashi Display Devices</td>
<td>DP-093</td>
</tr>
<tr>
<td>1</td>
<td>PCB</td>
<td>RoHS Compliant Bare PCB, PIC18F87J72 Evaluation Board</td>
<td></td>
<td>104-00333</td>
</tr>
<tr>
<td>1</td>
<td>Q1</td>
<td>IC REG LDO 800MA 5.0V SOT-223</td>
<td>National Semi.</td>
<td>LM1117MPX-5.0/NOPB</td>
</tr>
<tr>
<td>1</td>
<td>Q2</td>
<td>IC REG LDO 800MA 3.3V SOT-223</td>
<td>National Semi.</td>
<td>LM1117MPX-3.3/NOPB</td>
</tr>
<tr>
<td>11</td>
<td>R1, R2, R5, R11, R12, R15, R16, R17, R18, R19, R21</td>
<td>RES 1K OHM 1/10W 5% 0603 SMD</td>
<td>Stackpole Elec.</td>
<td>RMCF 1/16 1K 5% R</td>
</tr>
<tr>
<td>1</td>
<td>R3</td>
<td>RES 0.0 OHM 1/10W 0603 SMD</td>
<td>Stackpole Elec.</td>
<td>RMCF 1/16 0 R</td>
</tr>
<tr>
<td>7</td>
<td>R4, R7, R8, R47, R48, R49, R50</td>
<td>RES 100 OHM 1/10W 5% 0603 SMD</td>
<td>Stackpole Elec.</td>
<td>RMCF 1/16 100 5% R</td>
</tr>
<tr>
<td>1</td>
<td>R6</td>
<td>RES 10K OHM 1/10W 5% 0603 SMD</td>
<td>Stackpole Elec.</td>
<td>RMCF 1/16 10K 5% R</td>
</tr>
<tr>
<td>1</td>
<td>R9</td>
<td>RES 1.0 OHM 1/4W 5% 1206 SMD</td>
<td>ROHM Semi.</td>
<td>MCR18EZPJ1R0</td>
</tr>
<tr>
<td>2</td>
<td>R13, R14</td>
<td>RES 47.0 OHM 1/4W 1% 1206 SMD</td>
<td>ROHM Semi.</td>
<td>MCR18EZPF47R0</td>
</tr>
<tr>
<td>2</td>
<td>R20, R22</td>
<td>RES 470 OHM 1/10W 5% 0603 SMD</td>
<td>Stackpole Elec.</td>
<td>RMCF 1/16 470 5% R</td>
</tr>
<tr>
<td>4</td>
<td>R23, R24, R30, R31</td>
<td>RES 330K OHM 1/2W 5% 2010 SMD</td>
<td>ROHM Semi.</td>
<td>MCR50JZHJ334</td>
</tr>
<tr>
<td>2</td>
<td>R25, R32</td>
<td>RES 120K OHM 1/2W 5% 2010 SMD</td>
<td>ROHM Semi.</td>
<td>MCR50JZHJ124</td>
</tr>
<tr>
<td>4</td>
<td>R26, R27, R28, R29</td>
<td>RES 47 OHM 1/8W .1% 0805 SMD</td>
<td>Panasonic ECG</td>
<td>ERA-6AEB470V</td>
</tr>
<tr>
<td>10</td>
<td>R33, R34, R35, R36, R37, R38, R39, R40, R41, R42</td>
<td>RES 1.0K OHM 1/8W .1% 0805 SMD</td>
<td>SUSUMU Co.</td>
<td>RG2012P-102-B-T</td>
</tr>
<tr>
<td>4</td>
<td>R43, R44, R45, R46</td>
<td>RESISTOR 1.0 OHM 1/10W 5% 0603</td>
<td>Panasonic ECG</td>
<td>ERJ-3GEYJ1R0V</td>
</tr>
<tr>
<td>1</td>
<td>U1</td>
<td>80-Pin, High-Performance Microcontrollers with Dual-Channel AFE, LCD Driver and nanoWatt Technology TQFP-80</td>
<td>Microchip Tech. Inc.</td>
<td>PIC18F87J72-I/PT</td>
</tr>
<tr>
<td>1</td>
<td>U2</td>
<td>512K I2C Serial EEPROM SOIC-8</td>
<td>Microchip Tech. Inc.</td>
<td>24LC512-I/SM</td>
</tr>
<tr>
<td>2</td>
<td>U3, U6</td>
<td>OPTOCOUPLER LOGIC OUT VDE 6-SMD</td>
<td>Fairchild Semi.</td>
<td>H11L1SR2VM</td>
</tr>
<tr>
<td>1</td>
<td>U4</td>
<td>USB 2.0 to UART protocol Converter with GPIO SSOP-20</td>
<td>Microchip Technology Inc.</td>
<td>MCP2200-I/SO</td>
</tr>
<tr>
<td>1</td>
<td>U5</td>
<td>IC ESD PROTECTION LO CAP SOT23-6</td>
<td>STMicroelectronics</td>
<td>USBLC6-2SC6</td>
</tr>
<tr>
<td>1</td>
<td>X1</td>
<td>CRYSTAL 10.000MHZ 18PF SMD</td>
<td>ECS Ltd.</td>
<td>ECS-100-18-5PX-TR</td>
</tr>
<tr>
<td>1</td>
<td>X2</td>
<td>CRYSTAL 32.768 KHZ 12.5PF CYL</td>
<td>ECS Ltd.</td>
<td>ECS-327-12.5-13X</td>
</tr>
<tr>
<td>1</td>
<td>X3</td>
<td>CRYSTAL 12.000MHZ 18PF SMD</td>
<td>ECS Ltd.</td>
<td>ECS-120-18-5PX-TR</td>
</tr>
</tbody>
</table>
# Worldwide Sales and Service

## AMERICAS

**Corporate Office**  
2355 West Chandler Blvd.  
Chandler, AZ 85224-6199  
Tel: 480-792-7200  
Fax: 480-792-7277  
Technical Support: [http://www.microchip.com/support](http://www.microchip.com/support)  
Web Address: [www.microchip.com](http://www.microchip.com)

**Atlanta**  
Duluth, GA  
Tel: 678-957-9614  
Fax: 678-957-1455

**Boston**  
Westborough, MA  
Tel: 774-447-0087  
Fax: 774-447-0088

**Chicago**  
Itasca, IL  
Tel: 630-285-0071  
Fax: 630-285-0075

**Cleveland**  
Independence, OH  
Tel: 216-447-0464  
Fax: 216-447-0643

**Dallas**  
Addison, TX  
Tel: 972-818-7423  
Fax: 972-818-2924

**Detroit**  
Farmington Hills, MI  
Tel: 248-538-2250  
Fax: 248-538-2260

**Indianapolis**  
Independence, OH  
Tel: 317-773-8323  
Fax: 317-773-5453

**Los Angeles**  
Mission Viejo, CA  
Tel: 949-462-9523  
Fax: 949-462-9608

**Santa Clara**  
Santa Clara, CA  
Tel: 408-961-6444  
Fax: 408-961-6445

**Toronto**  
Mississauga, Ontario, Canada  
Tel: 905-673-0699  
Fax: 905-673-6509

## ASIA/PACIFIC

**Asia Pacific Office**  
Suites 3707-14, 37th Floor  
Tower 6, The Gateway  
Harbour City, Kowloon  
Hong Kong  
Tel: 852-2401-1200  
Fax: 852-2401-3431

**Australia - Sydney**  
Tel: 61-2-9868-6733  
Fax: 61-2-9868-6755

**China - Beijing**  
Tel: 86-10-8569-7000  
Fax: 86-10-8528-2104

**China - Chengdu**  
Tel: 86-28-8665-5511  
Fax: 86-28-8665-7889

**China - Chongqing**  
Tel: 86-23-8980-9588  
Fax: 86-23-8980-9500

**China - Hangzhou**  
Tel: 86-571-2819-3180  
Fax: 86-571-2819-3189

**China - Hong Kong SAR**  
Tel: 852-2500-1200  
Fax: 852-2501-3431

**China - Nanjing**  
Tel: 86-25-8473-2460  
Fax: 86-25-8473-2470

**China - Qingdao**  
Tel: 86-532-5502-7355  
Fax: 86-532-5502-7205

**China - Shanghai**  
Tel: 86-21-5407-5533  
Fax: 86-21-5407-5066

**China - Shenyang**  
Tel: 86-24-2334-2829  
Fax: 86-24-2334-2393

**China - Shenzhen**  
Tel: 86-755-8203-2660  
Fax: 86-755-8203-1760

**China - Wuhan**  
Tel: 86-27-5980-5300  
Fax: 86-27-5980-5118

**China - Xian**  
Tel: 86-29-8833-7252  
Fax: 86-29-8833-7256

**China - Xiamen**  
Tel: 86-592-2388338  
Fax: 86-592-2388130

**China - Zhuhai**  
Tel: 86-756-3210040  
Fax: 86-756-3210049

## ASIA/PACIFIC

**India - Bangalore**  
Tel: 91-80-3090-4444  
Fax: 91-80-3090-4123

**India - New Delhi**  
Tel: 91-11-4160-8631  
Fax: 91-11-4160-8632

**India - Pune**  
Tel: 91-20-2566-1512  
Fax: 91-20-2566-1513

**Japan - Yokohama**  
Tel: 81-45-471-6166  
Fax: 81-45-471-6122

**Korea - Daegu**  
Tel: 82-53-744-4301  
Fax: 82-53-744-4302

**Korea - Seoul**  
Tel: 82-2-554-7200  
Fax: 82-2-558-5932 or 82-2-558-5934

**Malaysia - Kuala Lumpur**  
Tel: 60-3-6201-9857  
Fax: 60-3-6201-9859

**Malaysia - Penang**  
Tel: 60-4-227-8870  
Fax: 60-4-227-4068

**Philippines - Manila**  
Tel: 63-2-634-9065  
Fax: 63-2-634-9069

**Singapore**  
Tel: 65-6334-8870  
Fax: 65-6334-8850

**Taiwan - Hsin Chu**  
Tel: 886-3-6578-300  
Fax: 886-3-6578-370

**Taiwan - Kaohsiung**  
Tel: 886-7-213-7830  
Fax: 886-7-330-9305

**Taiwan - Taipei**  
Tel: 886-2-2500-6610  
Fax: 886-2-2508-0102

**Thailand - Bangkok**  
Tel: 66-2-694-1351  
Fax: 66-2-694-1350

## EUROPE

**Austria - Wels**  
Tel: 43-7242-2244-39  
Fax: 43-7242-2244-393

**Denmark - Copenhagen**  
Tel: 45-4450-2828  
Fax: 45-4485-2829

**France - Paris**  
Tel: 33-1-69-53-63-20  
Fax: 33-1-69-30-90-79

**Germany - Munich**  
Tel: 49-89-627-144-0  
Fax: 49-89-627-144-44

**Italy - Milan**  
Tel: 39-0331-742611  
Fax: 39-0331-466781

**Netherlands - Drunen**  
Tel: 31-416-690399  
Fax: 31-416-690340

**Spain - Madrid**  
Tel: 34-91-708-08-90  
Fax: 34-91-708-08-91

**UK - Wokingham**  
Tel: 44-118-921-5869  
Fax: 44-118-921-5820

---

05/02/11